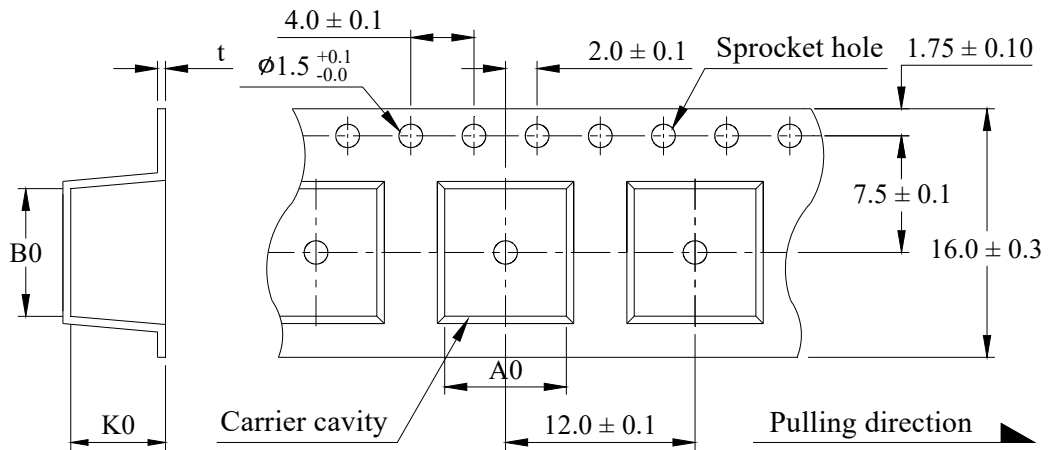


■ Packaging

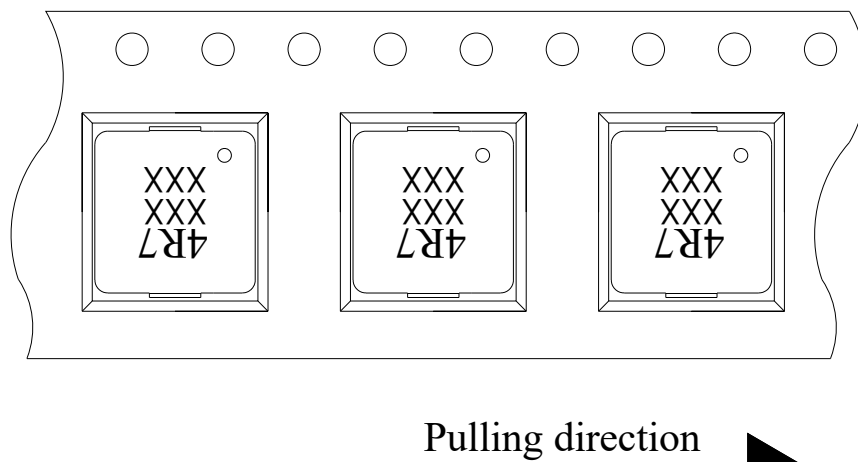
(1) Tape packaging dimensions



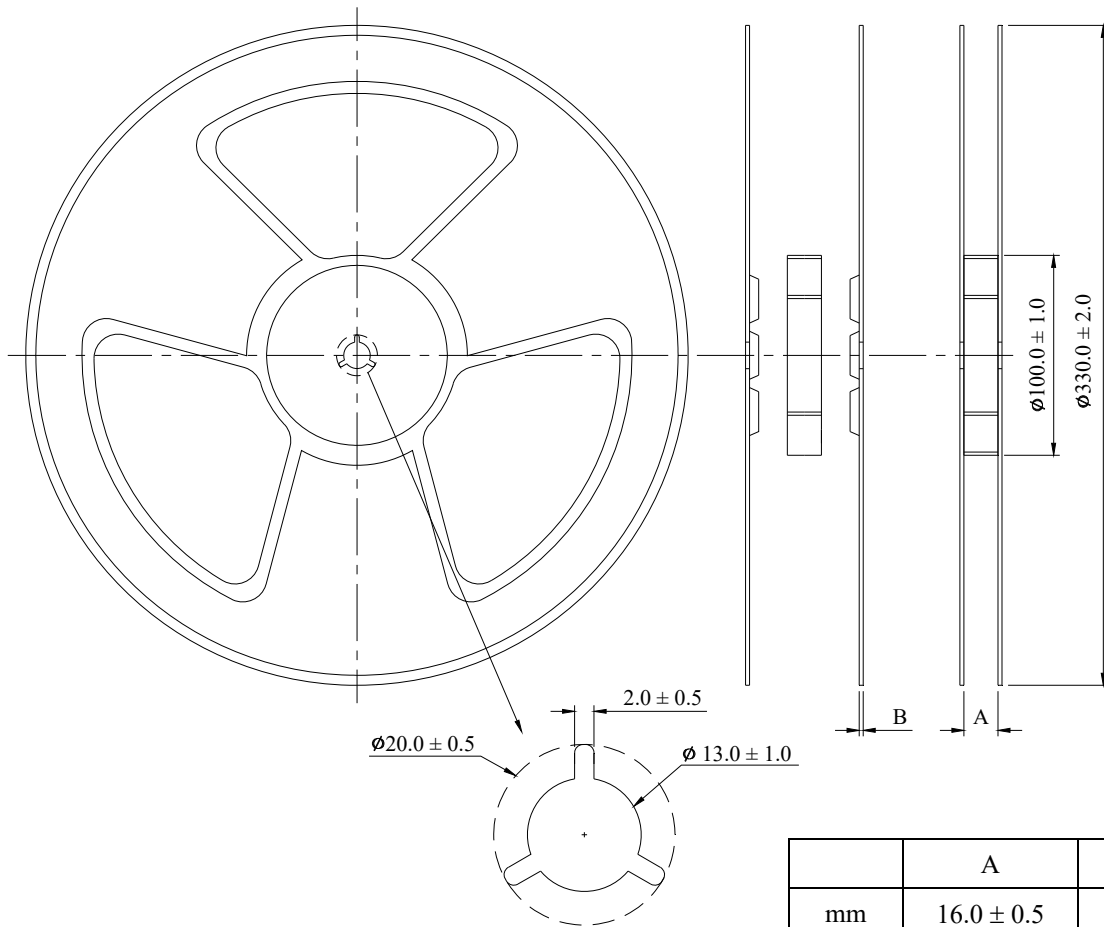
Dimensions Code (mm)				UNITS/REEL
A0	B0	K0	t	
7.7 ± 0.1	8.2 ± 0.1	6.0 ± 0.1	0.50 ± 0.05	500

(2) Tape Direction

The direction shall be seen from the top cover tape side.



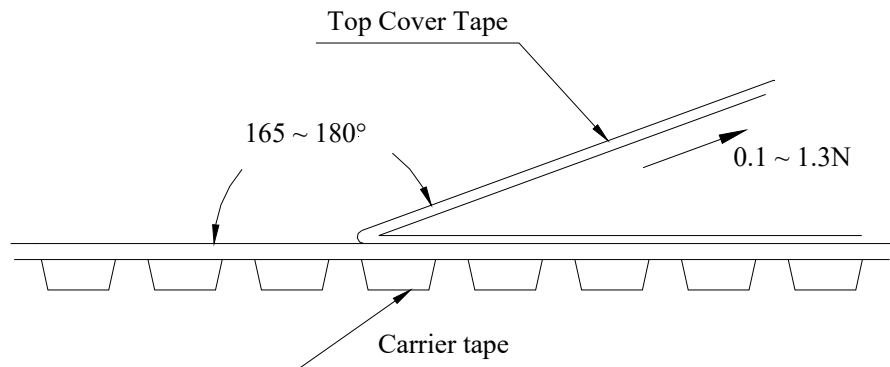
(3) Reel dimensions



(4) Peel force of top cover tape

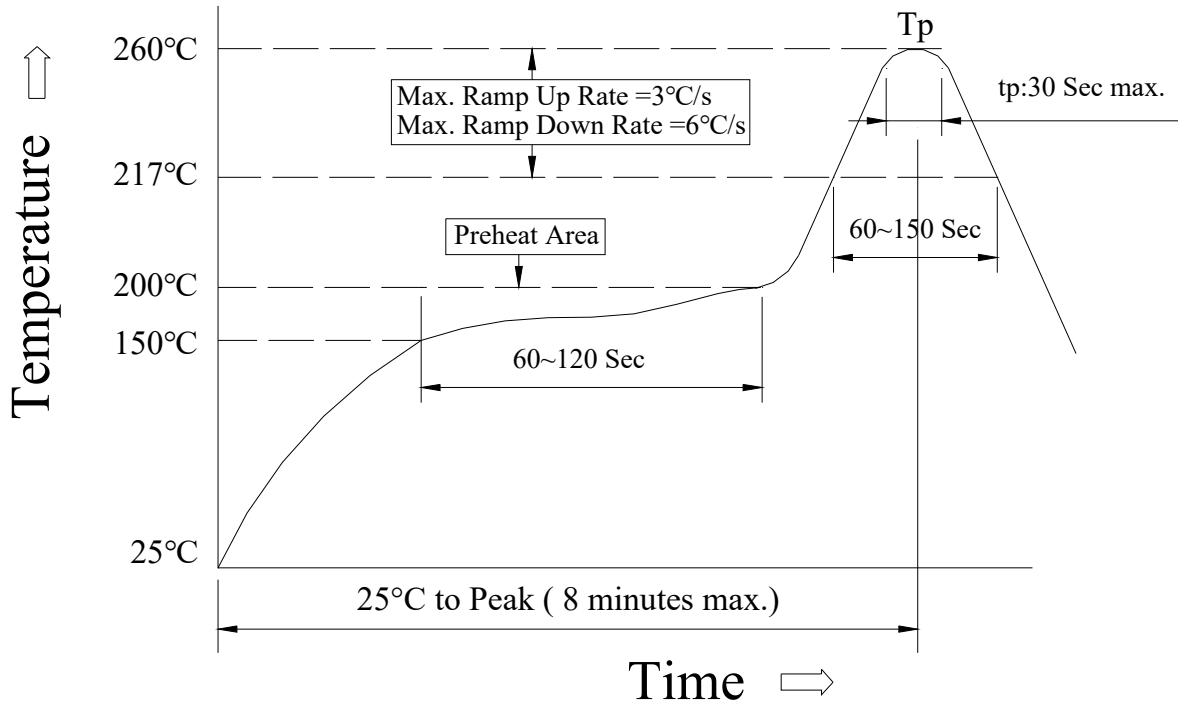
The peel speed shall be about 300 mm/minute.

The peel force of top cover tape shall be between 0.1 to 1.3N.



■ Reflow Profile

Power Choke Coil Type



(1) Reflow Soldering Method :

Reflow Soldering	Tp:255~260°C	Max.30 seconds (tp)
	217°C	60~150 seconds
Pre-Heat	150 ~ 200°C	60~120 seconds
Time 25°C to peak temperature	8 minutes max.	

(2) Soldering iron Method : 350 ± 5°C max.3 seconds.